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06-05-2001

U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office



101737958

Tab settings

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies): 05/23/01  
**Donald S. Farquhar**  
**Konstantinos I. Papathomas**

2. Name and address of receiving party(ies):

Name: International Business Machines Corporation

Internal Address: \_\_\_\_\_

Street Address: New Orchard Road

City: Armonk State: NY ZIP: 10504

Additional name(s) & address(es) attached?  Yes  No

Additional names(s) of conveying party(ies)  Yes  No

3. Nature of conveyance:

- Assignment  Merger
- Security Agreement  Change of Name
- Other \_\_\_\_\_

Execution Date: 5/18/01, 5/21/01

4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: 5/18/01, 5/21/01

A. Patent Application No.(s)

09/863961

B. Patent No.(s)

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Lawrence R. Fraley

Internal Address: \_\_\_\_\_

Street Address: IBM Corporation / IP Law N50/040-4,

1701 North Street

City: Endicott State: NY ZIP: 13760

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41):.....\$ 40.00

- Enclosed - Any excess or insufficiency should be credited or debited to deposit account
- Authorized to be charged to deposit account

8. Deposit account number:

09-0457

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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

Lawrence R. Fraley, Reg. No. 26,885

Name of Person Signing

Signature

May 22, 2001

Date

Total number of pages including cover sheet, attachments, and documents 3

J1017 U.S. PTO  
09/863961  
05/23/01

IBM Docket No.:  
END92000085US1

# ASSIGNMENT

Whereas, we

Inventor and City	(1) Donald S. Farquhar County of Broome	City of Endicott and State of NY
and	(2) Konstantinos I. Papathomas County of Tioga	City of Endicott and State of NY
and	(3) County of	City of and State of
and	(4) County of	City of and State of
and	(5) County of	City of and State of
and	(6) County of	City of and State of
and	(7) County of	City of and State of
and	(8) County of	City of and State of

have invented certain improvements in

Title **HOLE FILL COMPOSITION AND METHOD FOR FILLING HOLES IN A SUBSTRATE**

Dates That Inventors Signed the Declaration and have executed, respectively, a United States patent application therefor on

(1) <i>May 13, 2001</i>	and,	(2) <i>May 21, 2001</i>	and,
<del>(3)</del>	and,	<del>(4)</del>	and,
<del>(5)</del>	and,	<del>(6)</del>	and,
<del>(7)</del>	and,	<del>(8)</del>	

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

(Signatures of Inventors on Page 2)

IBM Docket No.:  
END92000085US1

# ASSIGNMENT (Continued)

Title **HOLE FILL COMPOSITION AND METHOD FOR FILLING HOLES IN A SUBSTRATE**

City Date (1) Signed at **Endicott, NY**  
on May 18, 2001

Donald S Farquhar  
(Signature of Inventor)

**Donald S. Farquhar**  
(Typed Name of Inventor)

City Date (2) Signed at **Endicott, NY**  
on May 21, 2001

Konstantinos I. Papathomas  
(Signature of Inventor)

**Konstantinos I. Papathomas**  
(Typed Name of Inventor)

City Date (3) Signed at  
on \_\_\_\_\_

\_\_\_\_\_  
(Signature of Inventor)

\_\_\_\_\_  
(Typed Name of Inventor)

City Date (4) Signed at  
on \_\_\_\_\_

\_\_\_\_\_  
(Signature of Inventor)

\_\_\_\_\_  
(Typed Name of Inventor)

City Date (5) Signed at  
on \_\_\_\_\_

\_\_\_\_\_  
(Signature of Inventor)

\_\_\_\_\_  
(Typed Name of Inventor)

City Date (6) Signed at  
on \_\_\_\_\_

\_\_\_\_\_  
(Signature of Inventor)

\_\_\_\_\_  
(Typed Name of Inventor)

City Date (7) Signed at  
on \_\_\_\_\_

\_\_\_\_\_  
(Signature of Inventor)

\_\_\_\_\_  
(Typed Name of Inventor)

City Date (8) Signed at  
on \_\_\_\_\_

\_\_\_\_\_  
(Signature of Inventor)

\_\_\_\_\_  
(Typed Name of Inventor)